

N-channel 550 V, 0.06  $\Omega$  typ., 33 A MDmesh™ V Power MOSFET  
in TO-220 and TO-247 packages

Datasheet — production data

## Features

Order codes	$V_{DSS}$ @ $T_{Jmax}$	$R_{DS(on)}$ max	$I_D$
STP36N55M5	600 V	< 0.08 $\Omega$	33 A
STW36N55M5			

- Worldwide best  $R_{DS(on)}$  \* area
- Higher  $V_{DSS}$  rating and high dv/dt capability
- Excellent switching performance
- 100% avalanche tested

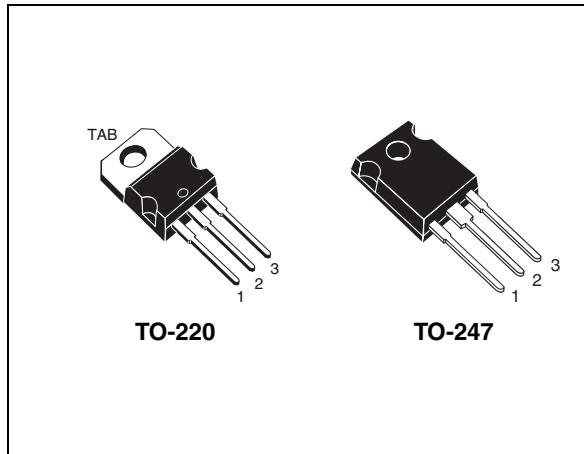
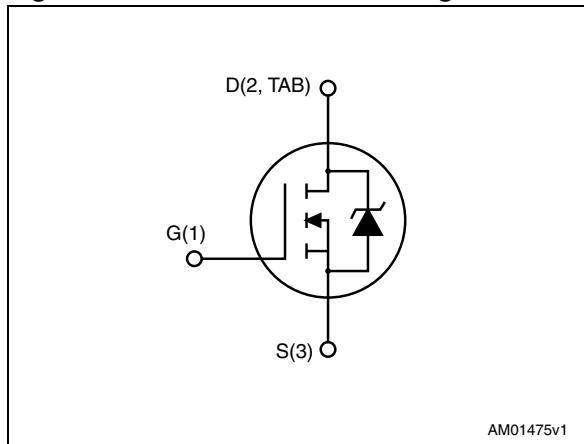


Figure 1. Internal schematic diagram



## Applications

- Switching applications

## Description

These devices are N-channel MDmesh™ V Power MOSFETs based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESHTM horizontal layout structure. The resulting product has extremely low on-resistance, which is unmatched among silicon-based Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Table 1. Device summary

Order codes	Marking	Package	Packaging
STP36N55M5	36N55M5	TO-220	Tube
STW36N55M5		TO-247	

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	$\pm 25$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	33	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	20.8	A
$I_{DM}^{(1)}$	Drain current (pulsed)	132	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	190	W
$dv/dt^{(1)}$	Peak diode recovery voltage slope	15	V/ns
$T_{stg}$	Storage temperature	- 55 to 150	$^\circ\text{C}$
$T_j$	Max. operating junction temperature	150	$^\circ\text{C}$

1.  $I_{SD} \leq 33 \text{ A}$ ,  $di/dt \leq 400 \text{ A}/\mu\text{s}$ ;  $V_{DS(\text{Peak})} < V_{(\text{BR})\text{DSS}}$ ,  $V_{DD} = 340 \text{ V}$ .

**Table 3. Thermal data**

Symbol	Parameter	Value		Unit
		TO-220	TO-247	
$R_{thj-case}$	Thermal resistance junction-case max	0.66		$^\circ\text{C}/\text{W}$
$R_{thj-amb}$	Thermal resistance junction-ambient max	62.5	50	$^\circ\text{C}/\text{W}$

**Table 4. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}$	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	7	A
$E_{AS}$	Single pulse avalanche energy (starting $T_j=25^\circ\text{C}$ , $I_D=I_{AR}$ ; $V_{DD}=50 \text{ V}$ )	510	mJ

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 5. On /off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	550			V
$I_{\text{DSS}}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = 550 \text{ V}$ $V_{DS} = 550 \text{ V}, T_C = 125^\circ\text{C}$			1 100	$\mu\text{A}$ $\mu\text{A}$
$I_{\text{GSS}}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 25 \text{ V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3	4	5	V
$R_{\text{DS(on)}}$	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 16.5 \text{ A}$		0.06	0.08	$\Omega$

**Table 6. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{\text{iss}}$ $C_{\text{oss}}$ $C_{\text{rss}}$	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0$	-	2670 75 6.6	-	pF pF pF
$C_{o(\text{tr})}^{(1)}$	Equivalent capacitance time related	$V_{DS} = 0 \text{ to } 440 \text{ V}, V_{GS} = 0$	-	192	-	pF
$C_{o(\text{er})}^{(2)}$	Equivalent capacitance energy related		-	71	-	pF
$R_G$	Intrinsic gate resistance	$f = 1 \text{ MHz open drain}$	-	1.85	-	$\Omega$
$Q_g$ $Q_{gs}$ $Q_{gd}$	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 440 \text{ V}, I_D = 16.5 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see <a href="#">Figure 18</a> )	-	62 15 27	-	nC nC nC

1. Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$
2. Energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{\text{oss}}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 7. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(V)}$	Voltage delay time	$V_{DD} = 400 \text{ V}$ , $I_D = 22 \text{ A}$ ,		56		ns
$t_{r(V)}$	Voltage rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 \text{ V}$	-	13	-	ns
$t_{f(i)}$	Current fall time	(see <a href="#">Figure 19</a> and <a href="#">Figure 22</a> )		13	-	ns
$t_{c(off)}$	Crossing time			17	-	ns

**Table 8. Source drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		33	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				132	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 33 \text{ A}$ , $V_{GS} = 0$	-		1.5	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 33 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$		334		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 100 \text{ V}$ (see <a href="#">Figure 22</a> )	-	5		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current			31	-	A
$t_{rr}$	Reverse recovery time	$I_{SD} = 33 \text{ A}$ , $dI/dt = 100 \text{ A}/\mu\text{s}$		406		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 100 \text{ V}$ , $T_j = 150^\circ\text{C}$	-	7		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	(see <a href="#">Figure 22</a> )		35	-	A

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220

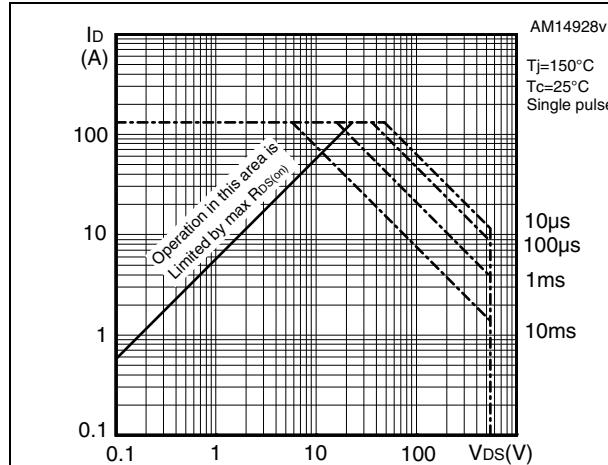


Figure 3. Thermal impedance for TO-220

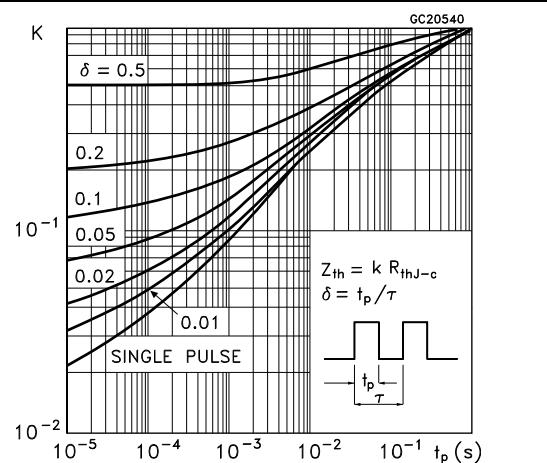


Figure 4. Safe operating area for TO-247

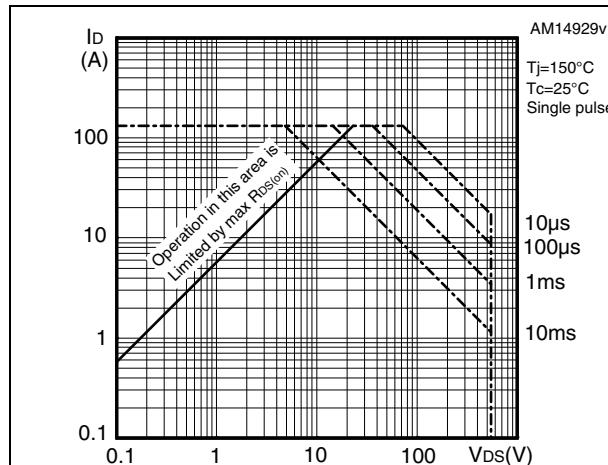


Figure 5. Thermal impedance for TO-247

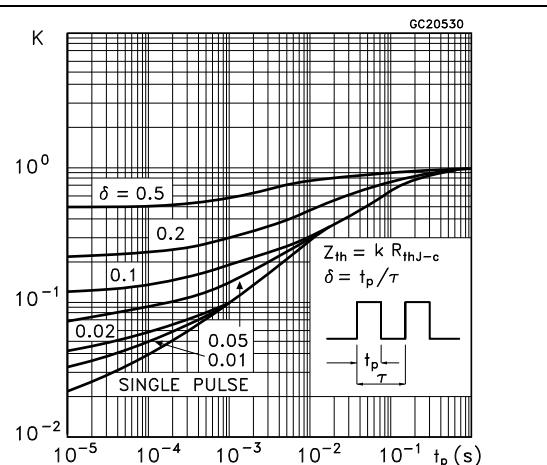


Figure 6. Output characteristics

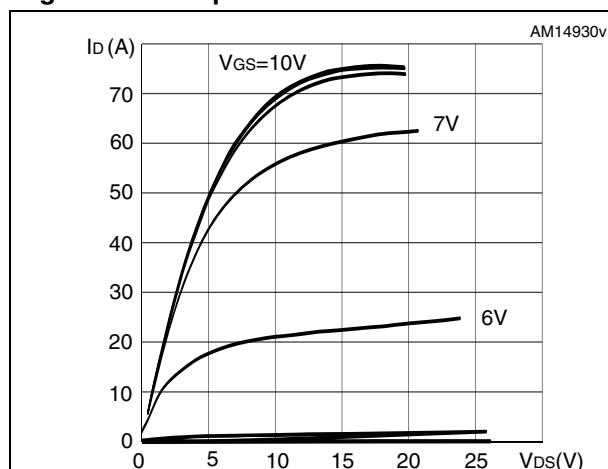
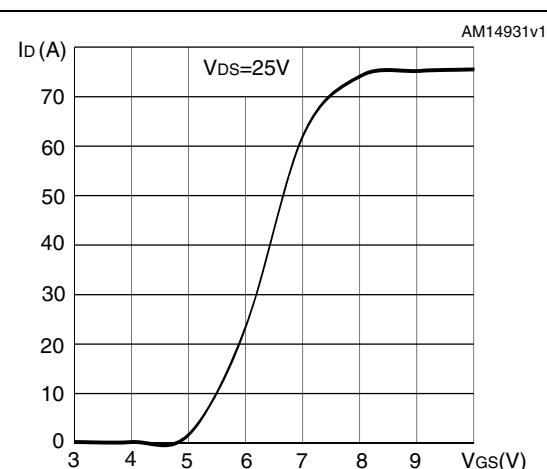
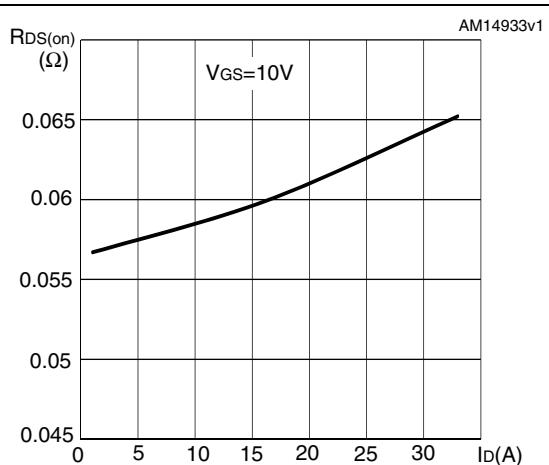
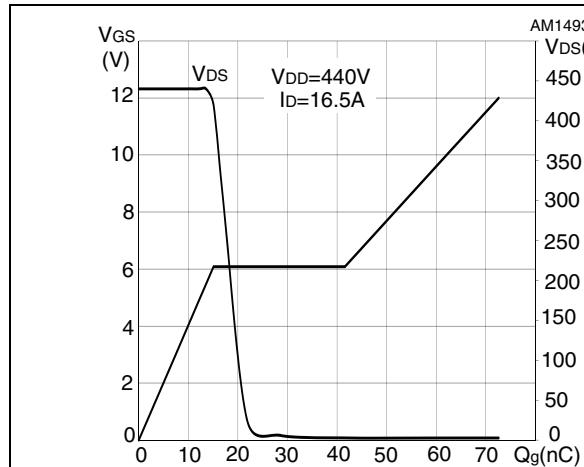
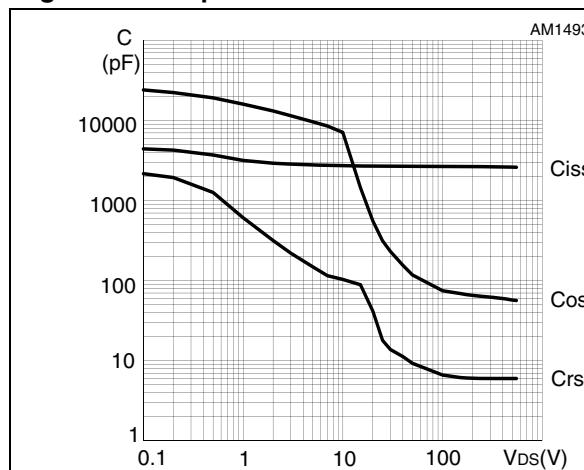
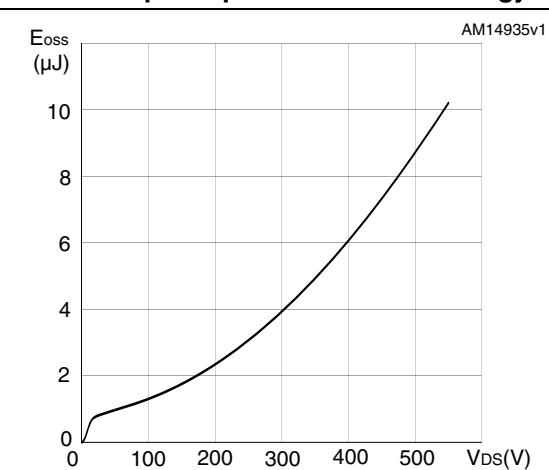
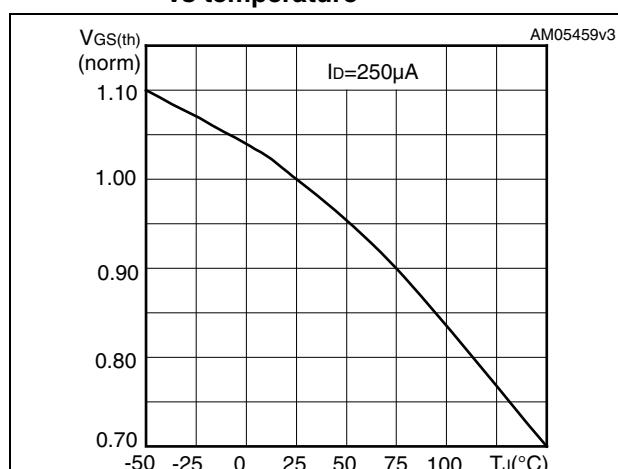
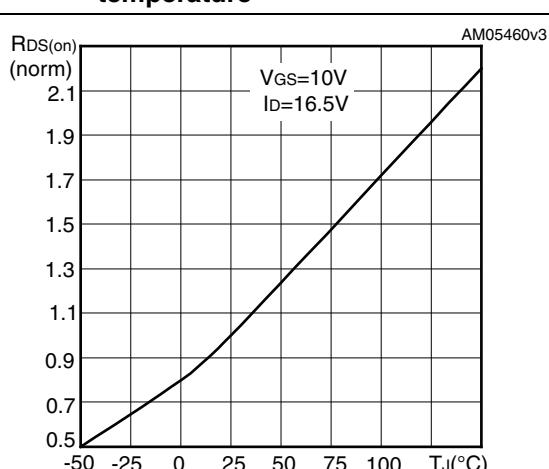
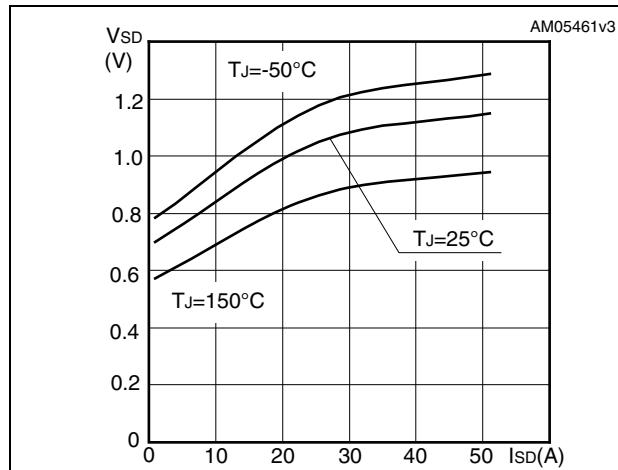


Figure 7. Transfer characteristics

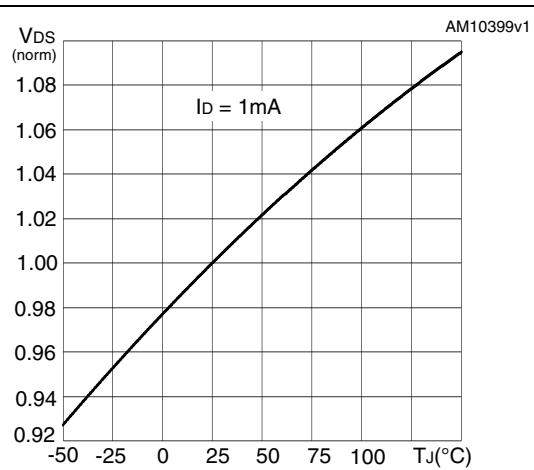


**Figure 8. Gate charge vs gate-source voltage****Figure 10. Capacitance variations****Figure 11. Output capacitance stored energy****Figure 12. Normalized gate threshold voltage vs temperature****Figure 13. Normalized on-resistance vs temperature**

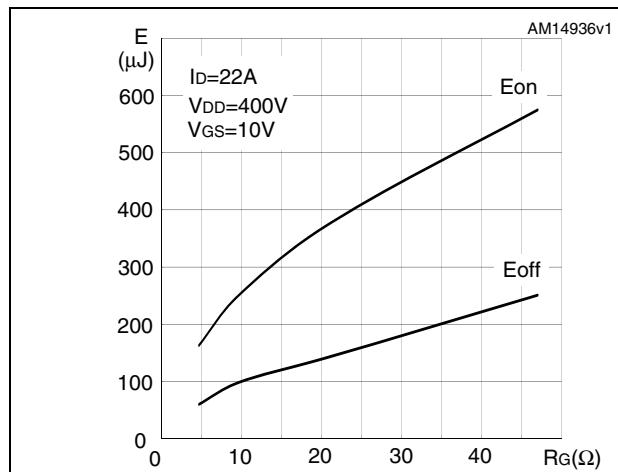
**Figure 14. Source-drain diode forward characteristics**



**Figure 15. Normalized  $B_{VDSS}$  vs temperature**



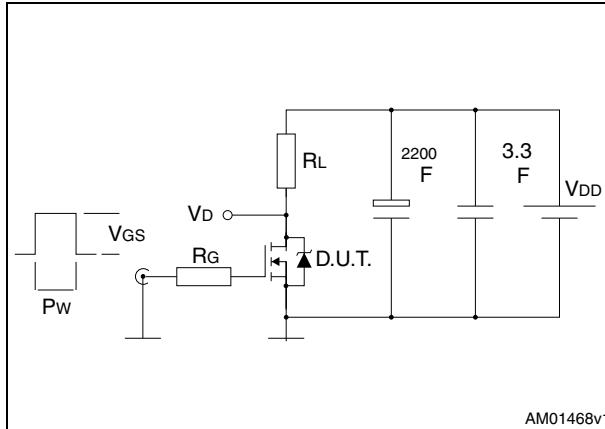
**Figure 16. Switching losses vs gate resistance (1)**



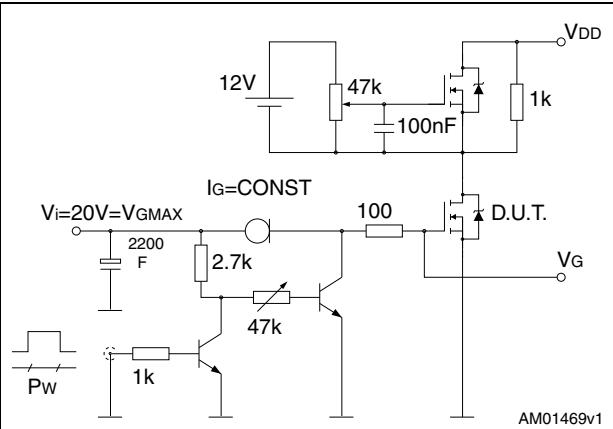
1.  $E_{on}$  including reverse recovery of a SiC diode

### 3 Test circuits

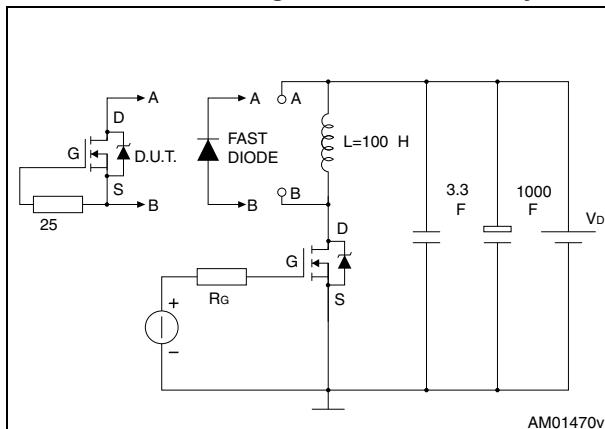
**Figure 17. Switching times test circuit for resistive load**



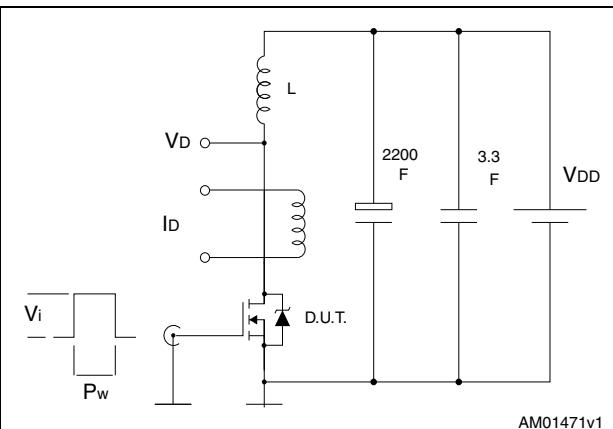
**Figure 18. Gate charge test circuit**



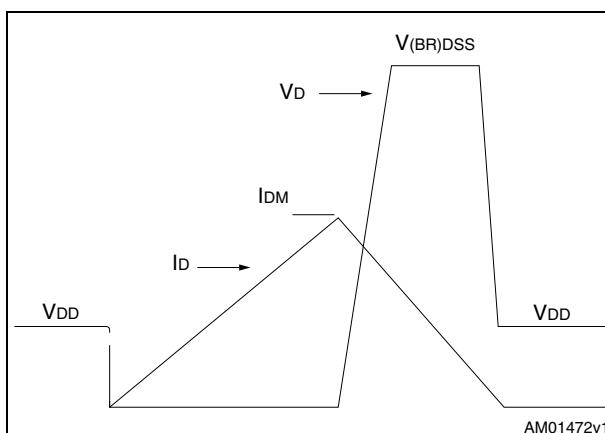
**Figure 19. Test circuit for inductive load switching and diode recovery times**



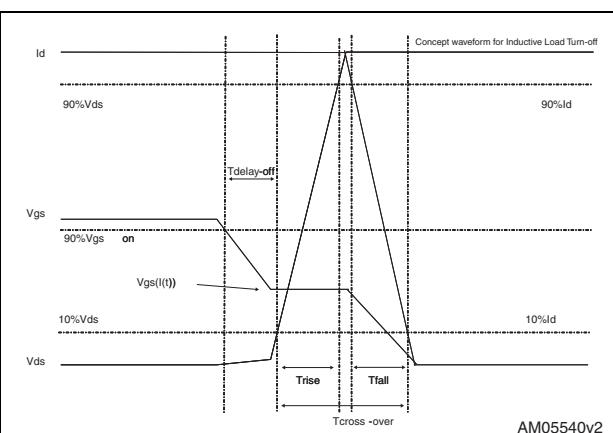
**Figure 20. Unclamped inductive load test circuit**



**Figure 21. Unclamped inductive waveform**



**Figure 22. Switching time waveform**

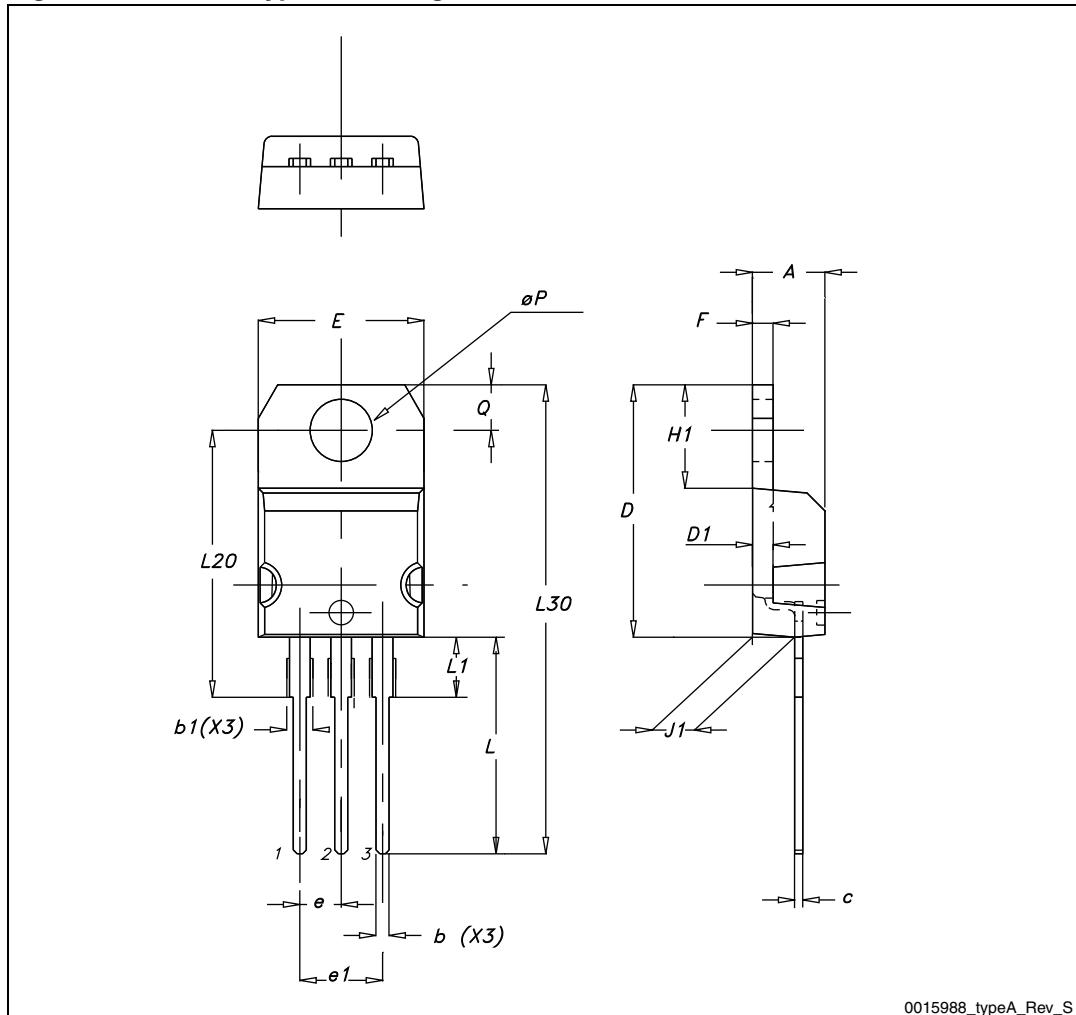


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

**Table 9. TO-220 type A mechanical data**

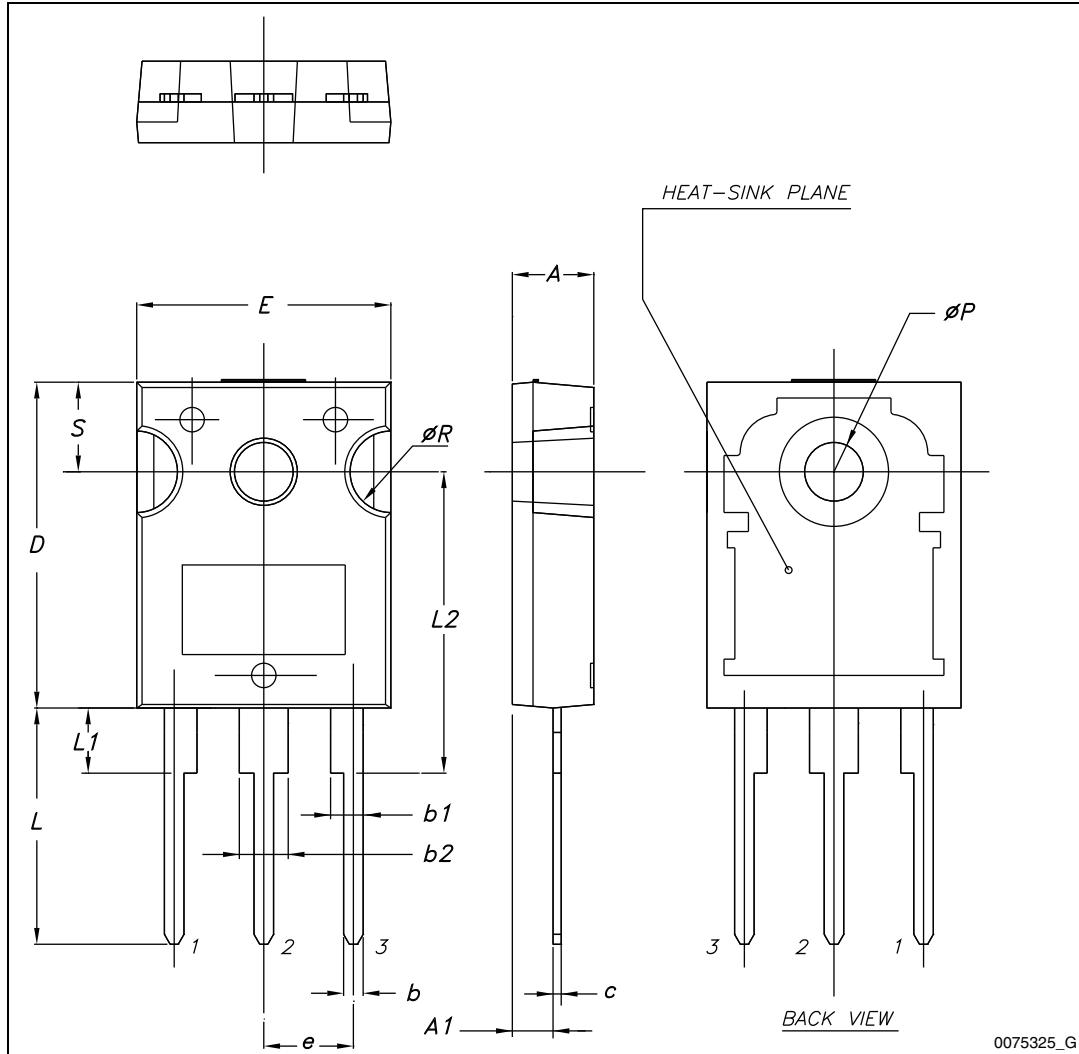
Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

**Figure 23.** TO-220 type A drawing

**Table 10.** TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Figure 24. TO-247 drawing



## 5 Revision history

**Table 11. Document revision history**

Date	Revision	Changes
07-Mar-2012	1	First release.
23-Oct-2012	2	Document status promoted from preliminary data to production data.

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